10/538482

JC06 Rec'd PCT/PTO 08 JUN 2005

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Date of Deposit: June 8, 2005

Case No. 9905/28 Client No. BIF023237/US

UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:)
FOURNEL et al.))
Serial No.: Not Yet Assigned) Examiner:) Not Yet Assigned
Filing Date: Herewith)) Group Art Unit:
For: METHOD FOR MAKING A STRESSED STRUCTURE DESIGNED TO BE DISSOCIATED) Not Yet Assigned)))

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents P.O. Box 1450 Alexandria, Virginia 22313-1450

Dear Sir:

In accordance with the duty of disclosure under 37 C.F.R. §1.56 and §§1.97-1.98, and more particularly in accordance with 37 C.F.R. §1.97(b), Applicants hereby cite the following references:

No.	Date of Publication	Patentee/Applicant/Country
5,400,458	03/28/1995	Huber et al.
4,254,590	03/10/1981	Eisele et al.
5,374,564,	12/20/1994	Bruel
FR 2 681 472 A1	03/19/1993	France
WO 00/48238	08/17/2000	PCT
EP 1 050 901 A2	11/08/2000	EPO
EP 0 410 679 A1	07/24/1990	EPO
101004013	07/05/1999	Japan

Feijoo et al., "Prestressing of Bonded Wafers", Proceedings of the 1st International Symposium on Semiconductor Wafer Bonding, Science Technology and Applications, Vol. 92-7, The Electrochemical Society (1992), pp. 230-238.

Feijoo et al., "Generalized Formula for Curvature Radius and Layer Stresses Caused by Thermal Strain in Semiconductor Multilayer Structures," Appl. Phys. 54(1), 1983, page 83.

S. Timoshenko, "Analysis of Bi-Metal Thermostats," J. Opt. Soc. Am. 11 (1925), page 233-256.



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For the Examiner's convenience, Applicants are enclosing Form PTO-1449 (one sheet). Reference FR 2681472A1 is a French patent application. In accordance with Rule 1.98 (a)(3), the applicant states that this document discloses a multistage process for producing a thin film. The Examiner is directed to the U.S. counterpart of FR 2681472; U.S. Patent No. 5,374,564, a copy of which is included herewith.

Applicants respectfully request the Examiner's consideration of the above references and entry thereof into the record of this application.

Also enclosed is a copy of the International Search Report issued on June 3, 2004 for corresponding PCT Application No. PCT/FR03/03622 of the above-identified application.

By submitting this Statement, Applicants are attempting to fully comply with the duty of candor and good faith mandated by 37 C.F.R. §1.56. As such, this Statement is not intended to constitute an admission that any of the enclosed references, or other information referred to therein, constitutes "prior art" or is otherwise "material to patentability," as that phrase is defined in 37 C.F.R. §1.56(a).

Applicants have calculated no fee to be due in connection with the filing of this Statement. However, the Director is authorized to charge any fee deficiency associated with the filing of this Statement to a deposit account, as authorized in the Transmittal accompanying this Statement.

Respectfully submitted,

June 8, 2005

Jasper W. Dockrey (Reg. No. 33,868)

Attorney for Applicants

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FORM PTO-1449	SERIAL NO. Not Yet Assigned	F155984982
		(BIF023237/US)
LIST OF PATENTS AND PUBLICATIONS FOR	FILING DATE	GROUP ART UNIT
APPLICANT'S INFORMATION DISCLOSURE	Herewith	Not Yet Assigned
STATEMENT		
	APPLICANTS: FOURNEL et al.	

REFERENCE DESIGNATION

U.S. PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER Number-Kind Code (if known)	DATE	NAME	CLASS/ SUBCLASS	FILING DATE
	A1	5,400,458	03/28/1995	Huber et al.		
	A2	4,254,590	03/10/1981	Eisele et al.		
	A3	5,374,564	12/20/1994	Bruel		

FOREIGN PATENT DOCUMENT

EXAMINER INITIAL		DOCUMENT NUMBER Number-Kind Code (if known)	DATE	COUNTRY	CLASS/ SUBCLAS S	TRANSLATION YES OR NO
	A4	FR 2 681 472 A1	03/19/1993	France		
	A5	WO 00/48238	08/17/2000	PCT		
	A6	EP 1 050 901 A2	11/08/2000	EPO		
	A7	EP 0 410 679 A1	07/24/1990	EPO		
	A8	101004013	07/05/1999	Japan		Abstract only

EXAMINER INITIAL	OTHER ART – NON PATENT LITERATURE DOCUMENTS (Include name of author, title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date page(s), volume-issue number(s), publisher, city and/or country where published					
	A9	Feijoo et al., "Prestressing of Bonded Wafers", Proceedings of the 1st International Symposium on Semiconductor Wafer Bonding, Science Technology and Applications, Vol. 92-7, The Electrochemical Society (1992), pp. 230-238.				
	A10	Feijoo et al., "Generalized Formula for Curvature Radius and Layer Stresses Caused by Thermal Strain in Semiconductor Multilayer Structures," Appl. Phys. 54(1), 1983, page 83.				
	A11	S. Timoshenko, "Analysis of Bi-Metal Thermostats," J. Opt. Soc. Am. 11 (1925), page 233-256.				

EXAMINER	DATE CONSIDERED	
	BATE CONCIDENCE	

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.